

ATTENTION **OBSERVE PRECAUTIONS** FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- 3.0x1.5x1.0mm right angle SMD LED, 1.0mm thickness.
- Low power consumption.
- · Wide viewing angle.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

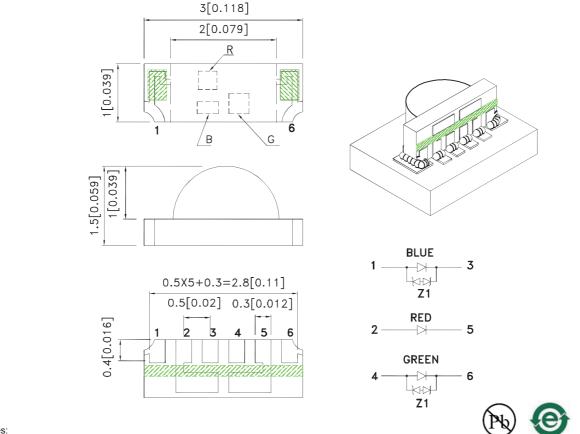
3.0x1.0mm RIGHT ANGLE SMD CHIP LED LAMP

Part Number: KPFA-3011BZ1RGZ1C-K13/F

Blue Hyper Red Green

Descriptions

- The Blue source color devices are made with InGaN Light Emitting Diode.
- The Hyper Red device is based on light emitting diode chip made from AlGaInP.
- The Green source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.



Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is ±0.2(0.008") unless otherwise noted.

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
The device has a single mounting surface. The device must be mounted according to the specifications.

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Package Dimensions

Selection Guide								
Part No.	Emitting Color	Lens Type	lv (mcd) [2] @ 20mA		lv (mcd) [2] @B:R:G=20mA: 16.6mA:17.9mA	Dice Chro- maticity Coordinates		Viewing Angle [1]
	(Material)		Min.	Тур.	Тур.	Х (Тур.)	Y (Typ.)	201/2
KPFA-3011BZ1RGZ1C-K13/F	Blue (InGaN)	Water Clear	55	110		0.3	0.3	155°
	Hyper Red (AlGaInP)		200	410	1180			145°
	Green (InGaN)		500	780				150°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity / luminous Flux: +/-15%.
Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at T_A=25°C

Parameter	Condition	Symbol		Unit		
		-	В	R	G	
Wavelength at Peak emission	I _F =20mA	λ peak	465	640	520	nm
Dominant Wavelength [1]	I _F =20mA	λ dom	470	625	525	nm
Spectral bandwidth at 50% Φ REL MAX	I _F =20mA	Δλ	22	20	35	nm
Forward Voltage [2]	I _F =20mA	V _F [typ.] V _F [max.]	3.3 4.0	2.2 2.8	3.2 4.0	V
Reverse Current	V _R =5V	I _R [max.]	10	10	10	uA

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at T_A=25°C

Parameter	Symbol		Value	Unit	
		В	R	G	Onit
Operating Temperature	Тор		°C		
Storage Temperature	Tstg	-40 To +85			°C
Junction Temperature	TJ	110	110	110	°C
Power dissipation	PD	120	84	120	mW
DC Forward Current [1]	I _F	30	30	30	mA
Peak Forward Current [2]	I _{FM}	100	150	100	mA
Electrostatic Discharge Threshold (HBM)		8000	3000	8000	V
Reverse Voltage	V _R	5	5	5	V
Junction/ambient 1 chip on	Rthj-a	400	290	400	°C/W
Junction/ambient 3 chip on	Rthj-a	610	630	590	°C/W

Notes:

1. Single-color light

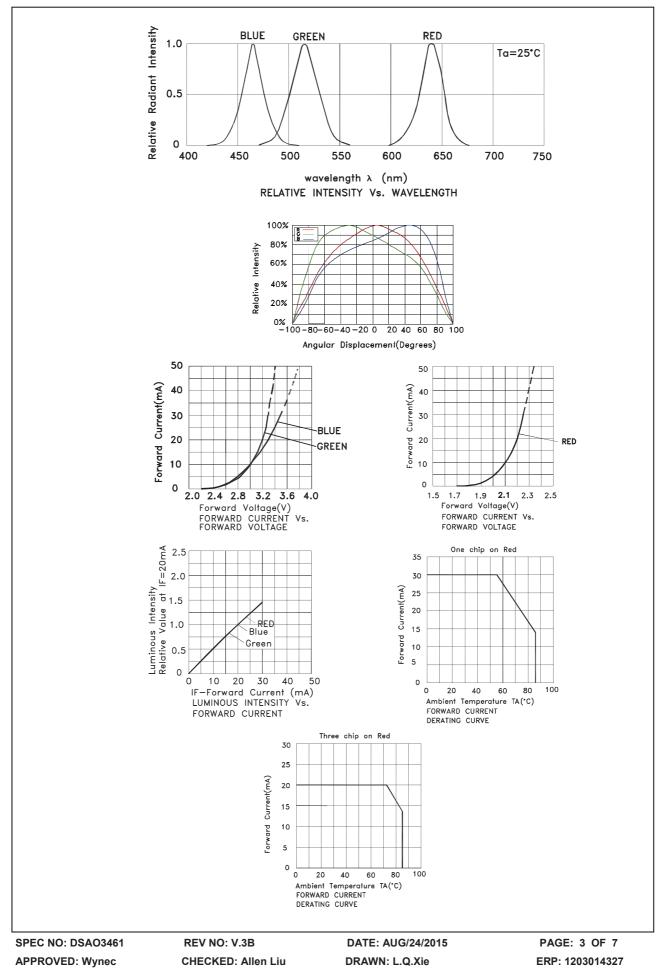
2. 1/10 Duty Cycle, 0.1ms Pulse Width.

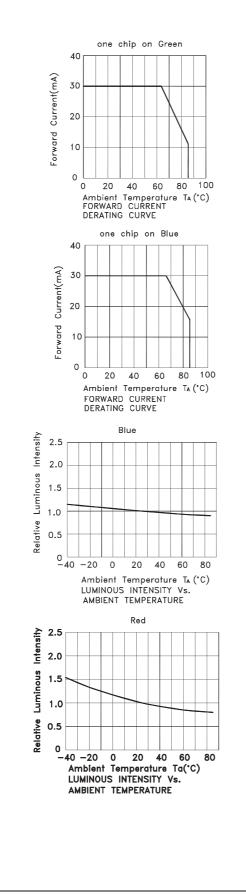
3. Value for total power dissipation when two and more chips are lit simultaneously.

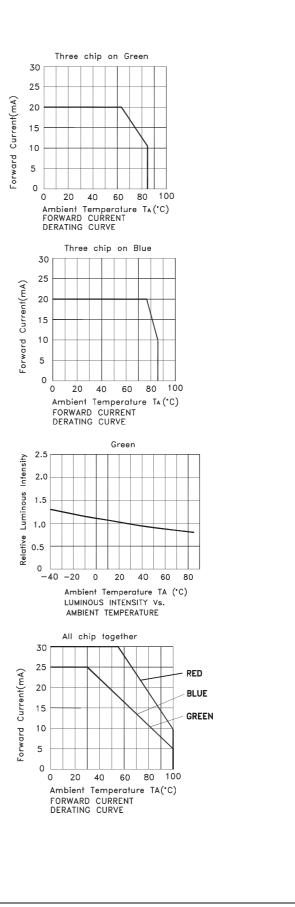
REV NO: V.3B CHECKED: Allen Liu

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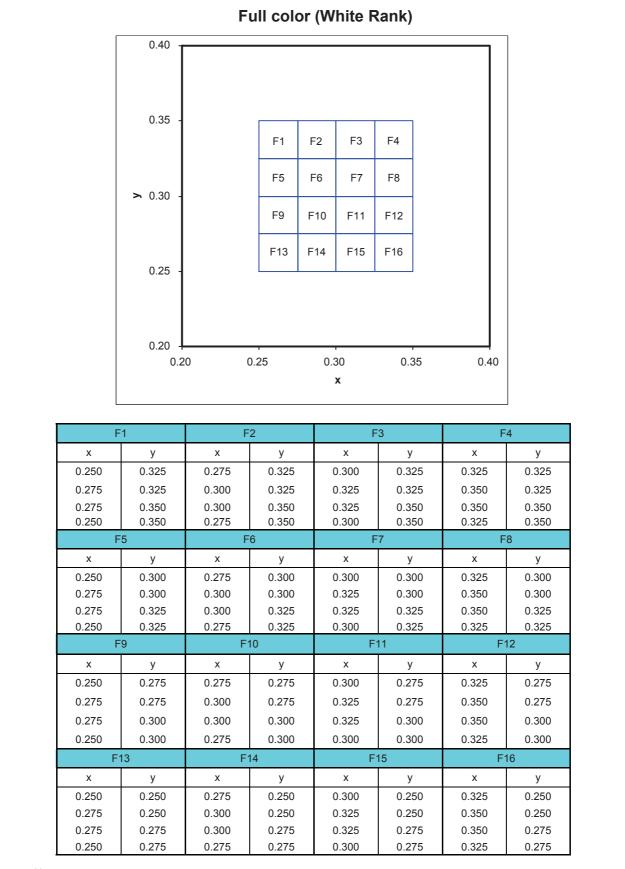
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Notes:

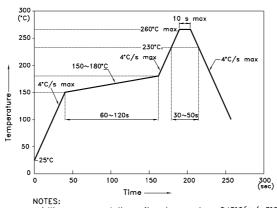
Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ± 0.01 .

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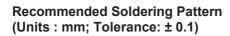
KPFA-3011BZ1RGZ1C-K13/F

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

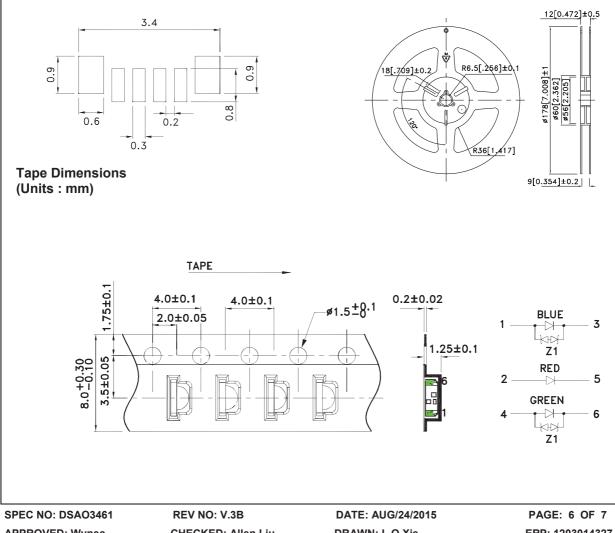
Reflow Soldering Profile For Lead-free SMT Process.

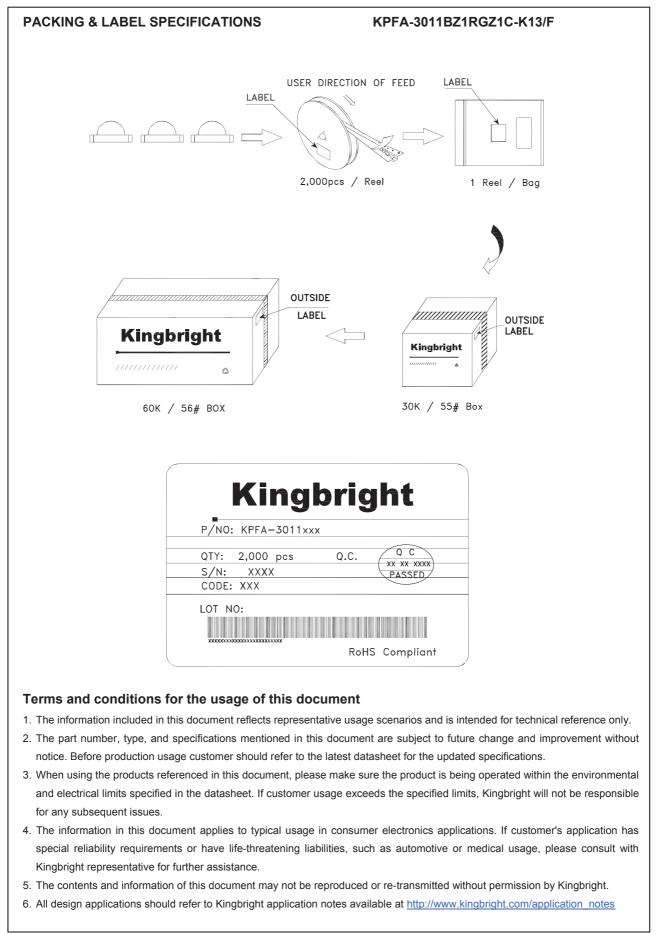


NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to be the temperature to high temperature. 3.Number of reflow process shall be 2 times or less.



Reel Dimension





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